

Features

- 5050 with integrated high quality constant current IC and RGBW LED chips.
- Built-in IC, with high precision of constant current and internal RGBW chips spectral processing in advance.
- Single line data transmission (return to zero code).
- Specific Shaping Transmit Technology number of LED stacked is not restricted.
- Cascading Enhancement Technology any 2 LED spacing can be up to 10 meters
- Data transfer rate of 800 kbp/s at 30 frames per second.
- RGBW output port PWM control can achieve 256 grey level adjustments.
- Upon powering up, IC performs self-inspection then lights connection on the pin B lamp.
- SA-I Anti-interference patent technology for single line data transmission.
- Built-in power supply reverse connect protection module, reversed power input will not damage the IC.

Description

The IN-PI55QATPRPGPBPW-XX is 5.0*5.0*1.6mm RGBW LED with integrated IC. It is a SMD type LED which can be used in various applications.

Applications

- Full color LED string light
- LED full color module
- LED guardrail tube
- LED scene lighting
- LED point light
- LED pixel screen
- LED shaped screen

Package Outline Dimensions & Pin Configuration

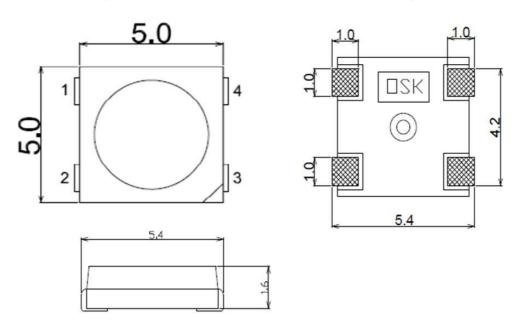


Figure 1. IN-PI55QATPRPGPBPW-XX Package Outline Dimensions



Pin Configuration

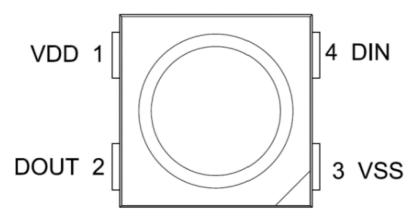


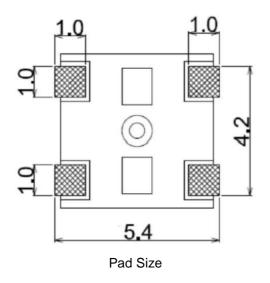
Figure 2. IN- PI55QATPRPGPBPW-XX Pin Configuration

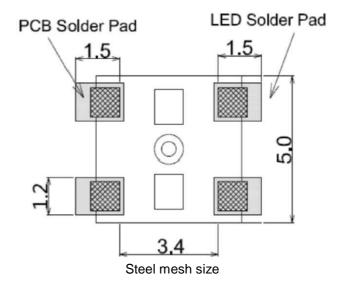
Notes

1. Dimension in millimeter, tolerance is ±0.1mm unless otherwise noted.

Number	Symbol	Function Description
1 VDD		Power supply LED
2	DOUT	Control data signal output
3	VSS	Ground
4 DIN		Control data signal input

Soldering Pad Size







Absolute Maximum Rating (Ta = 25 °C, VSS=0V)

Parameter	Symbol	Range	Unit
Power supply voltage	V _{DD}	+3.5~+5.5	V
Logic input voltage	VIN	-0.5 ~VDD+0.5	V
Working temperature	Торт	-45 ~ +85	°C
Storage temperature	Тѕтс	−50 ~ + 150	°C
ESD pressure(HBM)	Vesd	4K	V
ESD pressure(DM)	Vesd	200	V

LED Characteristics (Ta = 25°C)

Color	12mA				
Color	Wavelength(nm)	Light Intensity(mcd)			
Red	620-630	200-400			
Green	515-530	700-1000			
Blue	460-470	100-200			
Cool White	6000K	1500-2200			
Neutral White	4000k	1500-2200			
Warm White	3000k	1500-2200			

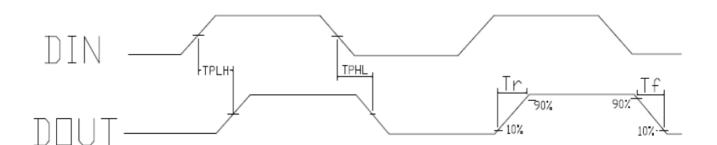
Recommended Operating Ranges (unless otherwise specified, Ta=-20 ~ +70 °C, VDD=4.5 ~ 5.5V, VSS=0V)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions
Supply voltage	V_{DD}	3.5	5.2	5.5	٧	-
R/G/B port pressure	V _{DS, MAX}	ı	ı	26	V	-
DOUT drive capability	ID _{он}	ı	49	-	mA	maximum source current
DOUT drive capability	ID _{OL}	1	-50	-	mA	maximum sink current
The signal input flip threshold	V _{IH}	0.7*+VDD	-		V	VDD=5.0V
The signal input flip threshold	$V_{\prime L}$	1	-	0.3*+VDD	V	VDD=5.0V
The frequency of PWM	F _{PWM}	-	1.2	-	KHZ	-
Static power consumption	I _{DD}	-	1	-	mA	-



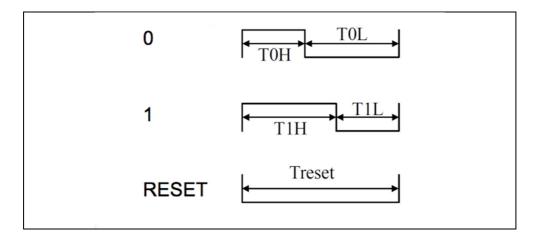
Switching Characteristics (unless otherwise specified, TA=25 °C)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions
The speed of data transmission	fDIN	-	800	ı	KHZ	The duty ratio of 67% (data 1)
DOLIT transmission dolay	T_{PLH}	-	ı	500	ns	DIN→DOUT
DOUT transmission delay	T_{PHL}	-	-	500	ns	וטטט⊸אווט
L Pico/Drop Timo	T _r	-	100	-	ns	VDS=1.5
I _{OUT} Rise/Drop Time	T_f	-	100	-	ns	IOUT=9~18mA



Timing Waveforms

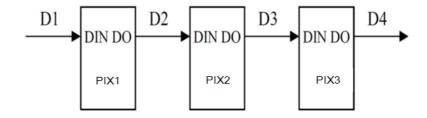
1. Input Code



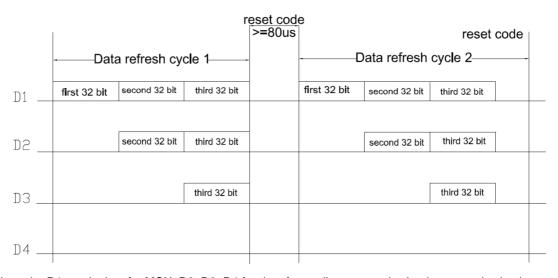
2. The data transmission time (TH+TL=1.25µs±600ns):

Name	Description	Typ. value	error
T0H	0 code, high level time	0.3µs	±0.15μs
T0L	0 code, low level time	0.9µs	±0.15μs
T1H	1 code, high level time	0.9µs	±0.15μs
T1L	1 code, low level time	0.3µs	±0.15μs
Trst	Reset code, low level time	80µs	

3. Connection Scheme



4. Data Transfer Format



Note: the D1 sends data for MCU, D2, D3, D4 for data forwarding automatic shaping cascade circuit.

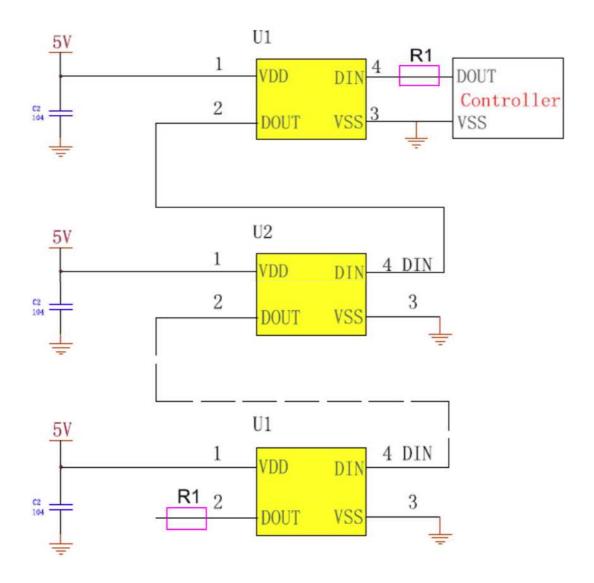
5. The data structure of 32bit

G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4
R3	R2	R1	RO	B7	B6	B5	B4	В3	B2	В1	ВО
W7	W6	W5	W4	W3	W2	W1	WO				

Note: high starting, in order to send data (G7 - G6 - W0)



Typical Application Circuit



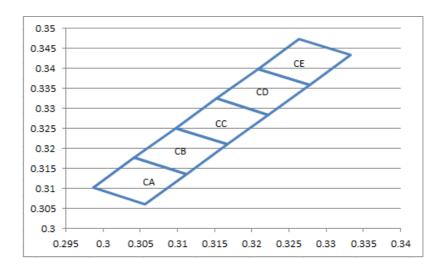
Product signal input and output must be connected in series with protection resistor R1. R1 depends on the size of the cascade amount, the greater the number of cascade, the smaller R1. The general recommended value is between 200-2K Ω , usually the recommended value is typical 500 Ω .



Color Bin Specification

Name	Code	λd MIN (nm)	λd MAX (nm)
Red	R1	620	625
Reu	R2	625	630
Blue	B5	460	465
Diue	B6	465	470
	G2	515	520
Green	G3	520	525
	G4	525	530

Cool White: 5000K~7500K



CA						
X	0.305649	0.29869	0.30422	0.31118		
Y	0.30617	0.31022	0.31765	0.3136		

		CB		
X	0.311181	0.30422	0.30975	0.31671
Y	0.3136	0.31765	0.32508	0.32103

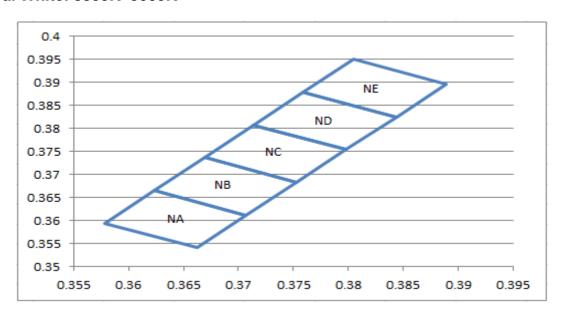
		CC		
X	0.316713	0.30975	0.31529	0.32225
Υ	0.32103	0.32508	0.33252	0.32847

CD							
X	0.322245	0.31529	0.32082	0.32778			
Y	0.32847	0.33252	0.33995	0.3359			

		CE		
X	0.327777	0.32082	0.32635	0.33331
Υ	0.3359	0.33995	0.34738	0.34333



Neutral White: 3500K~5000K



		NA		
X	0.3662	0.3578	0.3623	0.3707
Υ	0.3541	0.3594	0.3666	0.3612

		NC		
X	0.3753	0.3669	0.3714	0.3798
Υ	0.3683	0.3737	0.3808	0.3754

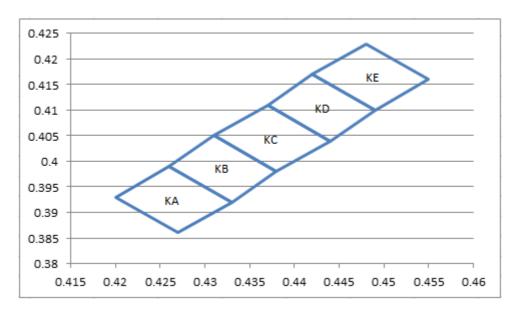
		NE		
X	0.3844	0.3759	0.3805	0.3889
Y	0.3825	0.3879	0.395	0.3897

		NB		
X	0.3707	0.3623	0.3669	0.3753
Υ	0.3612	0.3666	0.3737	0.3683

		ND		
X	0.3798	0.3714	0.3759	0.3844
Y	0.3754	0.3808	0.3879	0.3825



Warm White: 2700K~3500K



		KA		
X	0.427	0.42	0.426	0.433
Υ	0.386	0.393	0.399	0.392

KB					
X	0.433	0.426	0.431	0.438	
Y	0.392	0.399	0.405	0.398	

KC					
X	0.438	0.431	0.437	0.444	
Y	0.398	0.405	0.411	0.404	

KD					
X	0.444	0.437	0.442	0.449	
Υ	0.404	0.411	0.417	0.41	

		KE		
X	0.449	0.442	0.448	0.455
Υ	0.41	0.417	0.423	0.416

Wavelength Characteristics

100%

80%

60%

40%

20%

0.00

400

BLUE

500

450

550

600

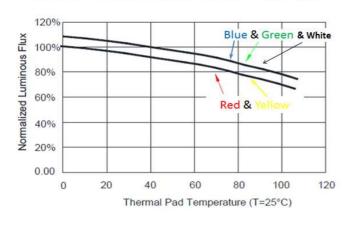
Wavelength (nm)

Relative Emission Distribution



LED Performance Graph

Thermal Pad Temperature vs. Relative Light Output



GREEN RED WS NW BW

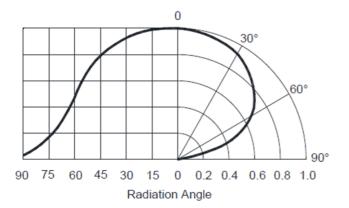
650

700

800

750

Typical Radiation Pattern 120°

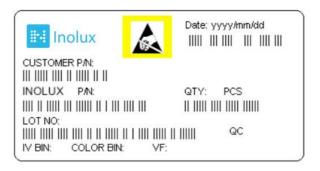




Ordering Information

Product	Emission Color	Iv (mcd) Typ.	Wavelength (Wd) / CCT Typ.	Orderable Part Number
	R	300	625	
IN DISCONTENDED DEDWING	G	850	520	IN DISCOATED DO DED W CO
IN-PI55QATPRPGPBPW-60	В	150	465	IN-PI55QATPRPGPBPW-60
	W	1850	6000k	
	R	300	625	
IN-PI55QATPRPGPBPW-40	G	850	520	IN-PI55QATPRPGPBPW-40
IN-PISSQATPRPGPBPW-40	В	150	465	- IN-PISSQATPRPGPBPW-40
	W	1850	4000k	
IN-PI55QATPRPGPBPW-30	R	300	625	
	G	850	520	IN-PI55QATPRPGPBPW-30
	В	150	465	IN-FIDOGATERPGPBPW-30
	W	1850	3000k	

Label Specifications



Inolux P/N:

Ι		N	PI	-	55	Q	Α	Т	(X)		ı	XX	1	Χ	Χ	Χ	Χ
			Product		Package	Die Qty.	Variation	Orientation	Current	Color		Color Temperature of White		Customized Stamp-off			
1	nolux	PI- Single trace IC PC- Clock Function IC		55QA =	55QA = 5.0 x 5.0 x 1.6 mm			P=12mA 5 = 5mA	R = 624nm G = 520nm B = 470nm W = 2700K-7000K		60: Cool White 40: Neutral White 30: Warm White						

Lot No.:

	Z	2	0	1	7	01	24	001	
Ī	Internal		Voor (2017	, 2018,)	Month	Data	Serial		
	Tracker		fear (2017	, 2016,)		IVIOITLIT	Date	Seriai	

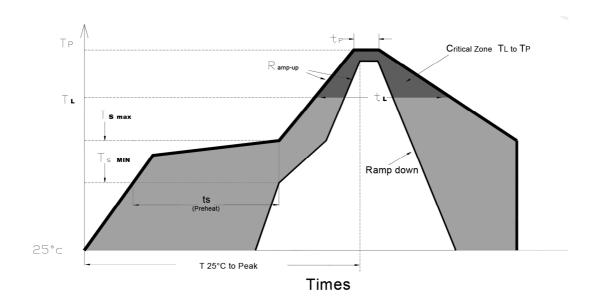


Precautions

Please read the following notes before using the product:

- 1. Storage
- 1.1 Do not open moisture proof bag before the products are ready to use.
- 1.2 Before opening the package, the LEDs should be kept at 30℃ or less and 80%RH or less.
- 1.3 The LEDs should be used within a year.
- 1.4 After opening the package, the LEDs should be kept at 30° C or less and 60° RH or less.
- 1.5 The LEDs should be used within 24 hours (1 days) after opening the package.
- 1.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ for 24 hours.

2. Soldering Condition Recommended soldering conditions:



Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3°C/second max.
Preheat: Temperature Min (Ts _{min})	150 °C
Preheat: Temperature Min (Ts _{max})	200 °C
Preheat: Time (ts _{min to} ts _{max})	60-180 seconds
Time Maintained Above: Temperature (T _L)	217 ℃
Time Maintained Above: Time (t L)	60-150 seconds
Peak/Classification Temperature (T P)	240 ℃
Time Within 5°C of Actual Peak Temperature (tp)	<10 seconds
Ramp-Down Rate	6°C/second max.
Time 25 °C to Peak Temperature	<6 minutes max.

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

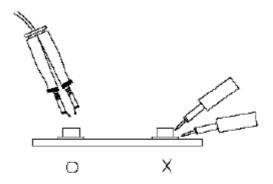


3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260° C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	05-31-2018
Format adjustment		1.1	07-01-2018
Format adjustment		1.2	08-06-2018

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